



YEA SHIN TECHNOLOGY CO., LTD

YS3908ZBB

N-Channel Enhancement MOSFET

VDS= 30V, ID= 48A



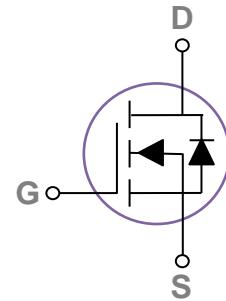
Features

- 30V, 48A, $R_{DS(ON)} = 8.5m\Omega$ @ VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

Applications

- MB / VGA / Vcore
- POL Buck Applications
- SMPS 2nd SR

PPAK3x3 Pin Configuration



Absolute Maximum Rating $T_c=25^\circ C$ unless otherwise noted

| Symbol | Parameter | Rating | Units |
|-----------|--|------------|-------|
| V_{DS} | Drain-Source Voltage | 30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Drain Current – Continuous ($T_c=25^\circ C$) | 48 | A |
| | Drain Current – Continuous ($T_c=100^\circ C$) | 30 | A |
| I_{DM} | Drain Current – Pulsed ¹ | 192 | A |
| EAS | Single Pulse Avalanche Energy ² | 45 | mJ |
| IAS | Single Pulse Avalanche Current ² | 30 | A |
| P_D | Power Dissipation ($T_c=25^\circ C$) | 35 | W |
| | Power Dissipation – Derate above 25°C | 0.28 | W/°C |
| T_{STG} | Storage Temperature Range | -55 to 150 | °C |
| T_J | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--|------|------|-------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | --- | 62 | °C /W |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case | --- | 3.6 | °C /W |

DEVICE CHARACTERISTICS

YS3908ZBB

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--|--|--|------|------|-----------|---------------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$ | 30 | --- | --- | V |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $I_D=1\text{mA}$ | --- | 0.04 | --- | $\text{V}/^\circ\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | μA |
| | | $V_{\text{DS}}=24\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=125^\circ\text{C}$ | --- | --- | 10 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$ | --- | --- | ± 100 | nA |

On Characteristics

| | | | | | | |
|---------------------|--|--|-----|-----|-----|----------------------------|
| $R_{\text{DS(ON)}}$ | Static Drain-source On-Resistance ³ | $V_{\text{GS}}=10\text{V}$, $I_D=16\text{A}$ | --- | 6.2 | 8.5 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}$, $I_D=8\text{A}$ | --- | 9 | 13 | $\text{m}\Omega$ |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$ | 1.2 | 1.6 | 2.5 | V |
| | | | --- | -4 | --- | $\text{mV}/^\circ\text{C}$ |
| g_{fs} | Forward Transconductance | $V_{\text{DS}}=10\text{V}$, $I_D=10\text{A}$ | --- | 9.5 | --- | S |

Dynamic and Switching Characteristics

| | | | | | | |
|---------------------|-----------------------------------|---|-----|------|------|----------|
| Q_g | Total Gate Charge ^{3,4} | $V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=4.5\text{V}$, $I_D=20\text{A}$ | --- | 7.5 | 12 | nC |
| Q_{gs} | Gate-Source Charge ^{3,4} | | --- | 1.3 | 2.6 | |
| Q_{gd} | Gate-Drain Charge ^{3,4} | | --- | 4.5 | 8 | |
| $T_{\text{d(on)}}$ | Turn-On Delay Time ^{3,4} | $V_{\text{DD}}=15\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_G=3.3\Omega$, $I_D=15\text{A}$ | --- | 4.8 | 9 | ns |
| T_r | Rise Time ^{3,4} | | --- | 12.5 | 24 | |
| $T_{\text{d(off)}}$ | Turn-On Delay Time ^{3,4} | | --- | 27.6 | 52 | |
| T_f | Fall Time ^{3,4} | | --- | 8.2 | 16 | |
| C_{iss} | Input Capacitance | $V_{\text{DS}}=25\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 680 | 1000 | pF |
| C_{oss} | Output Capacitance | | --- | 150 | 220 | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 70 | 105 | |
| R_g | Gate Resistance | $V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 2.7 | 5.4 | Ω |

Guaranteed Avalanche Energy

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------|-------------------------------|--|------|------|------|-------------|
| EAS | Single Pulse Avalanche Energy | $V_{\text{DD}}=25\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=15\text{A}$ | 12 | | | mJ |

Drain-Source Diode Characteristics and Maximum Ratings

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-----------------|------------------------------------|--|------|------|------|------|
| I_s | Continuous Source Current | $V_G=V_D=0\text{V}$, Force Current | --- | --- | 48 | A |
| I_{SM} | Pulsed Source Current ³ | | --- | --- | 192 | A |
| V_{SD} | Diode Forward Voltage ³ | $V_{\text{GS}}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | V |

Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{\text{DD}}=25\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=30\text{A}$, $R_g=25\Omega$, Starting $T_J=25^\circ\text{C}$.
- The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.

DEVICE CHARACTERISTICS

YS3908ZBB

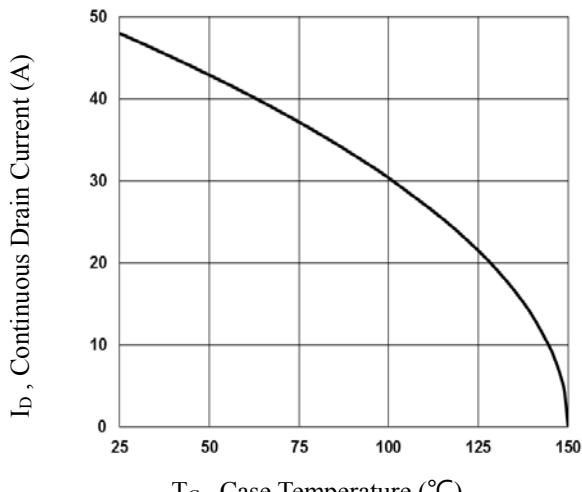


Fig.1 Continuous Drain Current vs. T_C

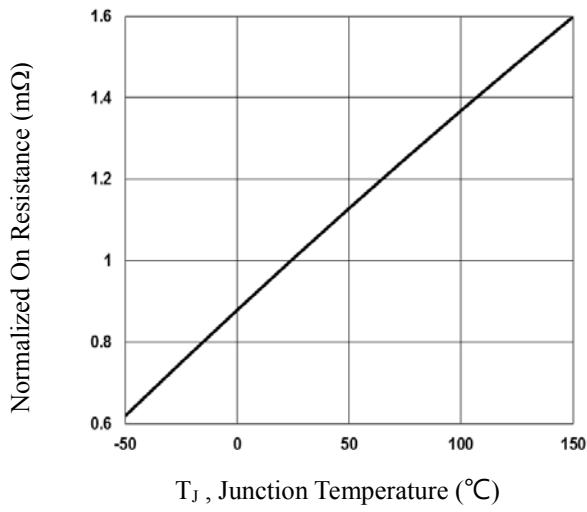


Fig.2 Normalized RDS(ON) vs. T_J

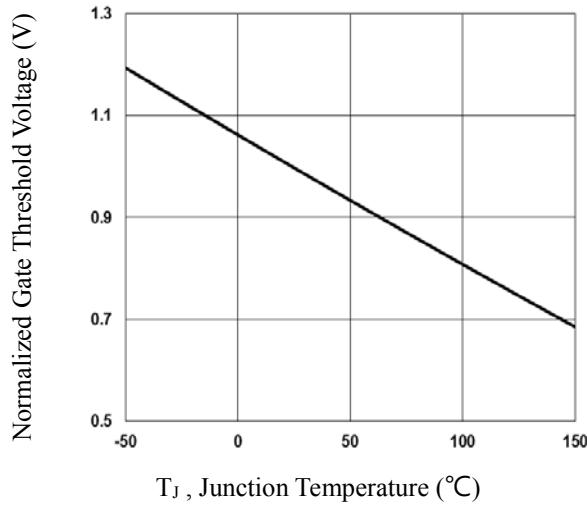


Fig.3 Normalized V_{th} vs. T_J

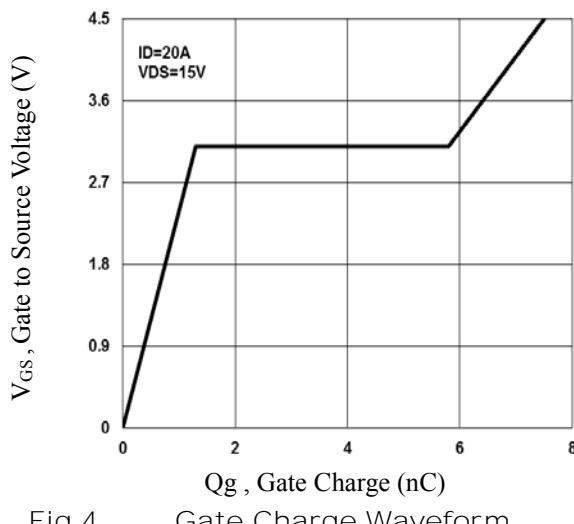


Fig.4 Gate Charge Waveform

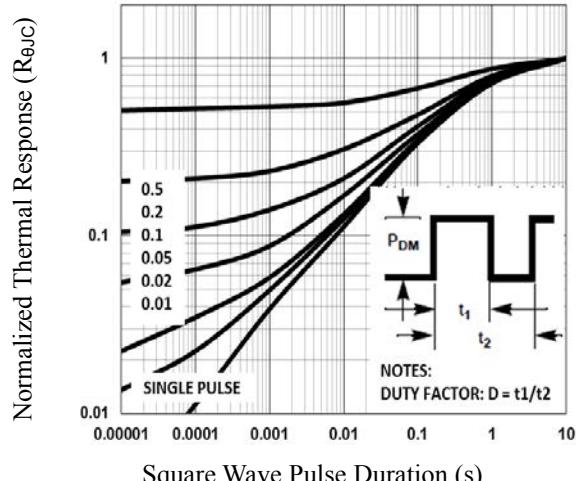


Fig.5 Normalized Transient Impedance

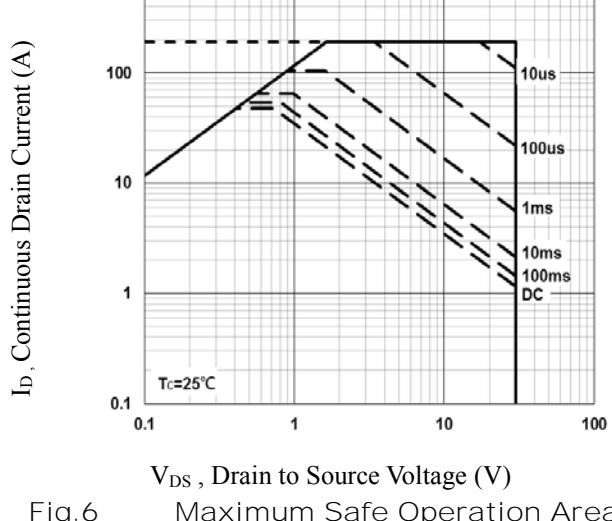


Fig.6 Maximum Safe Operation Area

DEVICE CHARACTERISTICS

YS3908ZBB

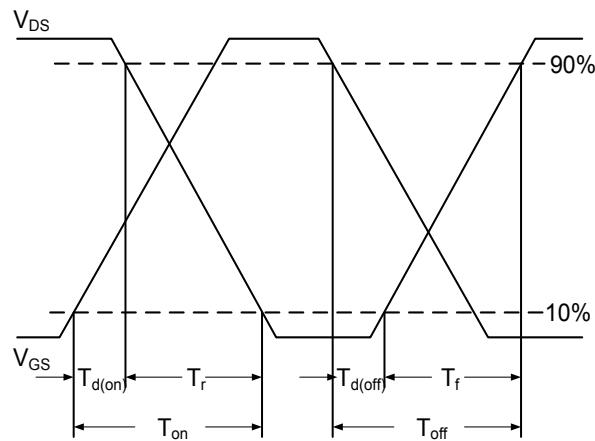


Fig.7 Switching Time Waveform

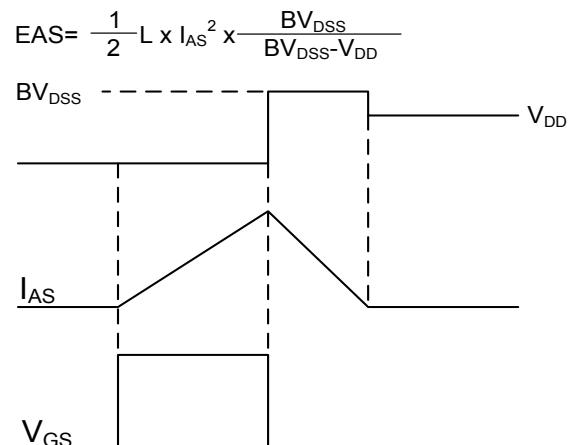
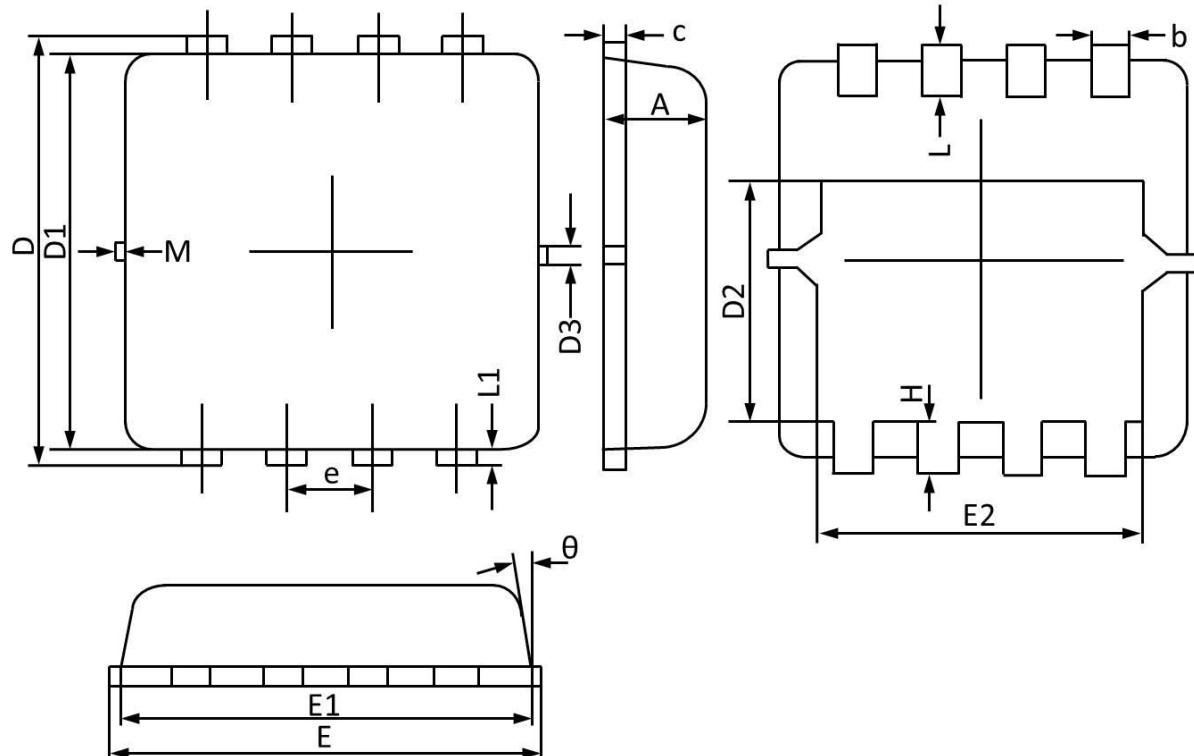


Fig.8 EAS Waveform

PACKAGE OUTLINE & DIMENSIONS

YS3908ZBB

PPAK3x3 PACKAGE INFORMATION



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 0.700 | 0.800 | 0.028 | 0.031 |
| b | 0.250 | 0.350 | 0.010 | 0.013 |
| c | 0.100 | 0.250 | 0.004 | 0.009 |
| D | 3.250 | 3.450 | 0.128 | 0.135 |
| D1 | 3.000 | 3.200 | 0.119 | 0.125 |
| D2 | 1.780 | 1.980 | 0.070 | 0.077 |
| D3 | 0.130 REF | | 0.005 REF | |
| E | 3.200 | 3.400 | 0.126 | 0.133 |
| E1 | 3.000 | 3.200 | 0.119 | 0.125 |
| E2 | 2.390 | 2.590 | 0.094 | 0.102 |
| e | 0.650 BSC | | 0.026 BSC | |
| H | 0.300 | 0.500 | 0.011 | 0.019 |
| L | 0.300 | 0.500 | 0.011 | 0.019 |
| L1 | 0.130 REF | | 0.005 REF | |
| θ | 0° | 12° | 0° | 12° |
| M | 0.150 REF | | 0.006 REF | |